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Dated: April 4, 2005

Signature: \_\_\_\_\_

(Michael R. Hill)

Docket No.: 30205/39512  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Sung Koo Lee et al.

Application No.: 10/719,355

Confirmation No.: 3322

Filed: November 21, 2003

Art Unit: 1752

For: PHOTORESIST POLYMER AND  
PHOTORESIST COMPOSITION INCLUDING  
THE SAME

Examiner: Sin J. Lee

**AMENDMENT AFTER ALLOWANCE UNDER 37 C.F.R. §1.312**

MS Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

Please amend the above-noted application as follows.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 9 of this paper.

Please  
Enter  
S.J.L.  
5/2/2006